

September 2009

MCT2M, MCT2EM, MCT210M, MCT271M Phototransistor Optocouplers

Features

- UL recognized (File # E90700, Vol. 2)
- IEC60747-5-2 recognized (File # 102497)

 Add option V (e.g., MCT2VM)

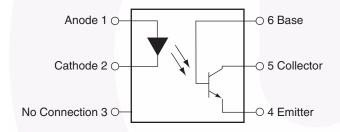
Applications

- Power supply regulators
- Digital logic inputs
- Microprocessor inputs

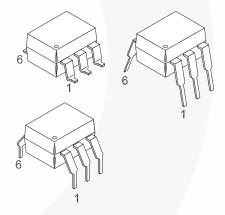
Description

The MCT2XXM series optoisolators consist of a gallium arsenide infrared emitting diode driving a silicon phototransistor in a 6-pin dual in-line package.

Schematic



Package Outlines



Absolute Maximum Ratings

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

| Symbol | Parameter | Value | Units |
|---------------------|--|----------------|-------|
| TOTAL DEVI | DE . | | |
| T _{STG} | Storage Temperature | -40 to +150 | °C |
| T _{OPR} | Operating Temperature | -40 to +100 | °C |
| T _{SOL} | Lead Solder Temperature | 260 for 10 sec | °C |
| P _D | Total Device Power Dissipation @ T _A = 25°C | 250 | mW |
| | Derate above 25°C | 2.94 | mW/°C |
| EMITTER | | | • |
| I _F | DC/Average Forward Input Current | 60 | mA |
| V _R | Reverse Input Voltage | 3 | V |
| I _F (pk) | Forward Current – Peak (300µs, 2% Duty Cycle) | 3 | А |
| P _D | LED Power Dissipation @ T _A = 25°C | 120 | mW |
| | Derate above 25°C | 1.41 | mW/°C |
| DETECTOR | | | |
| I _C | Collector Current | 50 | mA |
| V _{CEO} | Collector-Emitter Voltage | 30 | V |
| P _D | Detector Power Dissipation @ T _A = 25°C | 150 | mW |
| | Derate above 25°C | 1.76 | mW/°C |

Electrical Characteristics (T_A = 25°C unless otherwise specified)

Individual Component Characteristics

| Symbol | Parameter | Test Conditions | Device | Min. | Тур.* | Max. | Units |
|-------------------|--|---|----------------------------|------|-------|------|-------|
| EMITTER | | | | | | | |
| V _F | Input Forward Voltage | I _F = 20mA | MCT2M MCT2EM MCT271M | | 1.25 | 1.50 | V |
| | | $T_A = 0^{\circ}C - 70^{\circ}C$, $I_F = 40mA$ | MCT210M | | 1.33 | | |
| I _R | Reverse Leakage Current | V _R = 3.0V | MCT2M MCT2EM MCT271M | | 0.001 | 10 | μA |
| | | $T_A = 0$ °C -70 °C, $V_R = 6.0$ V | MCT210M | | | | |
| DETECTO | DR | | | | | | |
| BV _{CEO} | Collector-Emitter Breakdown Voltage | I _C = 1.0mA, I _F = 0 | ALL | 30 | 100 | | V |
| | | T _A = 0°C–70°C | MCT210M | | | | |
| BV _{CBO} | Collector-Base Breakdown Voltage | $I_C = 10\mu A, I_F = 0$ | MCT2M MCT2EM MCT271M | 70 | 120 | | V |
| | | T _A = 0°C-70°C | MCT210M | 30 | | | |
| BV _{ECO} | Emitter-Collector Breakdown Voltage | I _E = 100μA, I _F = 0 | MCT2M MCT2EM MCT271M | 7 | 10 | | V |
| | | T _A = 0°C–70°C | MCT210M | 6 | 10 | | |
| I _{CEO} | Collector-Emitter Dark | V _{CE} = 10V, I _F = 0 | ALL | | 1 | 50 | nA |
| | Current | $V_{CE} = 5V, T_A = 0^{\circ}C - 70^{\circ}C$ | | | | 30 | μΑ |
| I _{CBO} | Collector-Base Dark Current | V _{CB} = 10V, I _F = 0 | ALL | | | 20 | nA |
| C _{CE} | Capacitance | $V_{CE} = 0V, f = 1MHz$ | ALL | | 8 | | pF |

^{*}All typical $T_A = 25^{\circ}C$

Isolation Characteristics

| Symbol | Parameter | Test Conditions | Min | Тур* | Max | Units |
|------------------|--------------------------------|----------------------------|------------------|------|-----|---------|
| V _{ISO} | Input-Output Isolation Voltage | f = 60Hz, t = 1 sec. | 7500 | | | Vac(pk) |
| R _{ISO} | Isolation Resistance | V _{I-O} = 500 VDC | 10 ¹¹ | | / | Ω |
| C _{ISO} | Isolation Capacitance | | | 0.2 | 2 | pF |

^{*}All typicals at $T_A = 25^{\circ}C$

Electrical Characteristics (Continued) (T_A = 25°C unless otherwise specified)

Transfer Characteristics

| Symbol | Parameter | Test Conditions | Device | Min. | Тур.* | Max. | Unit | |
|----------------------|--|--|----------------------------|------|-------|------|------|--|
| DC CHARA | ACTERISTICS | | | | | | | |
| CTR | Output Collector | $T_A = 0$ °C -70 °C | MCT210M | 150 | | | % | |
| | Current | I _F = 10mA, V _{CE} = 10V | MCT2M MCT2EM | 20 | | | | |
| | | | MCT271M | 45 | | 90 | 1 | |
| | | $I_F = 3.2 \text{mA} \text{ to } 32 \text{mA},$ $V_{CE} = 0.4 \text{V}, T_A = 0^{\circ} \text{C} - 70^{\circ} \text{C}$ | MCT210M | 50 | | | | |
| V _{CE(SAT)} | Collector-Emitter Saturation Voltage | I _C = 2mA, I _F = 16mA | MCT2M MCT2EM MCT271M | | | 0.4 | V | |
| | | I _C = 16mA, I _F = 32mA, T _A = 0°C–70°C | MCT210M | | | | | |
| AC CHARA | ACTERISTICS | | | , | | | | |
| t _{on} | AC Characteristic Saturated Turn-on Time from 5V to 0.8V | $I_F = 15\text{mA}, V_{CC} = 5\text{V},$ $R_L = 2\text{k}\Omega, R_B = \text{Open (Fig. 11)}$ | MCT2M MCT2EM | | 1.1 | | μs | |
| | | $I_F = 20$ mA, $V_{CC} = 5$ V, $R_L = 2$ kΩ, $R_B = 100$ kΩ) (Fig. 11) | MCT2M MCT2EM | | 1.3 | | | |
| t _{off} | Saturated Turn-off Time from SAT to 2.0 V | I_F = 15mA, V_{CC} = 5V, R_L = 2kΩ, R_B = Open (Fig. 11) | MCT2M MCT2EM | | 50 | | μs | |
| | | $I_F = 20$ mA, $V_{CC} = 5$ V, $R_L = 2$ k $Ω$, $R_B = 100$ k $Ω$ (Fig. 11) | MCT2M MCT2EM | | 20 | | | |
| t _{on} | Turn-on Time | $I_F = 10 \text{mA}, V_{CC} = 10 \text{V},$ $R_L = 100 \Omega$ | MCT2M MCT2EM | | 2 | | μs | |
| t _{off} | Turn-off Time | $I_F = 10 \text{mA}, V_{CC} = 10 \text{V},$ $R_L = 100 \Omega$ | MCT2M MCT2EM | | 2 | | μs | |
| t _r | Rise Time | $I_F = 10 \text{mA}, V_{CC} = 10 \text{V},$ $R_L = 100 \Omega$ | MCT2M MCT2EM | | 2 | | μs | |
| t _f | Fall Time | $I_F = 10 \text{mA}, V_{CC} = 10 \text{V},$ $R_L = 100 \Omega$ | MCT2M MCT2EM | | 1.5 | | μs | |
| t _{on} | Saturated turn-on time | $I_F = 16\text{mA}, R_L = 1.9\text{k}\Omega,$ | MCT271M | | 1.0 | | μs | |
| t _{off} | Saturated turn-off time (Approximates a typical TTL interface) | V _{CC} = 5V (Fig. 11) | | | 48 | | μs | |
| t _{on} | Saturated turn-on time | $I_F = 16\text{mA}, R_L = 4.7\text{k}\Omega,$ | MCT271M | | 1.0 | | μs | |
| t _{off} | Saturated turn-off time (Approximates a typical low power TTL interface) | V _{CC} = 5 V (Fig. 20) | | | 98 | | μs | |
| t _r | Saturated rise time | $I_F = 16 \text{mA}, R_L = 560 \Omega,$ | MCT210M | | 1.0 | | μs | |
| t _f | Saturated fall time | V _{CC} = 5V) (Fig. 11, 12) | | | 11 | // [| μs | |
| T _{PD (HL)} | Saturated propagation delay – HIGH to LOW | I_F = 16mA, R_L = 2.7kΩ (Fig. 11, 12) | MCT210M | | 1.0 | | μs | |
| T _{PD (LH)} | Saturated propagation delay – LOW to HIGH | | | | 50 | | μs | |
| t _r | Non-saturated rise time | I _C = 2mA, V _{CC} = 5V, | MCT210M | | 2 | | μs | |
| t _f | Non-saturated fall time | $R_L = 100\Omega \text{ (Fig. 11)}$ | | | 2 | | μs | |
| t _{on} | Non-saturated turn-on time | I _C = 2mA, V _{CC} = 5V, | MCT271M | | 2 | 7 | μs | |
| t _{off} | Non-saturated turn-off time | $R_{L} = 100\Omega \text{ (Fig. 20)}$ | | | 2 | 7 | μs | |

^{*}All typicals at $T_A = 25^{\circ}C$

Safety and Insulation Ratings

As per IEC 60747-5-2, this optocoupler is suitable for "safe electrical insulation" only within the safety limit data. Compliance with the safety ratings shall be ensured by means of protective circuits.

| Symbol | Parameter | Min. | Тур. | Max. | Unit |
|-------------------|---|-----------------|-----------|------|-------------------|
| | Installation Classifications per DIN VDE 0110/1.89 Table 1 | | | | |
| | For Rated Main Voltage < 150Vrms | | I-IV | | |
| | For Rated Main voltage < 300Vrms | | I-IV | | |
| | Climatic Classification | | 55/100/21 | | |
| | Pollution Degree (DIN VDE 0110/1.89) | | 2 | | |
| CTI | Comparative Tracking Index | 175 | | | |
| V _{PR} | Input to Output Test Voltage, Method b, V _{IORM} x 1.875 = V _{PR} , 100% Production Test with tm = 1 sec, Partial Discharge < 5pC | 1594 | | | V _{peak} |
| | Input to Output Test Voltage, Method a, V _{IORM} x 1.5 = V _{PR} , Type and Sample Test with tm = 60 sec, Partial Discharge < 5pC | 1275 | | | V _{peak} |
| V _{IORM} | Max. Working Insulation Voltage | 850 | | | V _{peak} |
| V_{IOTM} | Highest Allowable Over Voltage | 6000 | | | V _{peak} |
| | External Creepage | 7 | | | mm |
| | External Clearance | 7 | | | mm |
| | Insulation Thickness | 0.5 | | | mm |
| RIO | Insulation Resistance at Ts, V _{IO} = 500V | 10 ⁹ | | | Ω |

Typical Performance Curves

Fig. 1 LED Forward Voltage vs. Forward Current

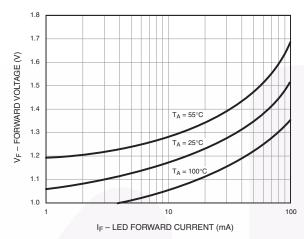


Fig. 2 Normalized CTR vs. Forward Current

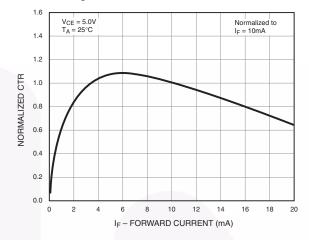


Fig. 3 Normalized CTR vs. Ambient Temperature

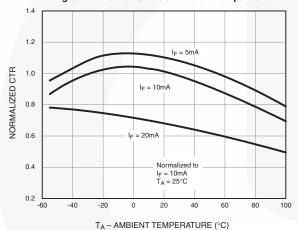


Fig. 4 CTR vs. RBE (Unsaturated)

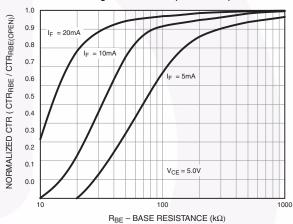


Fig. 5 CTR vs. RBE (Saturated)

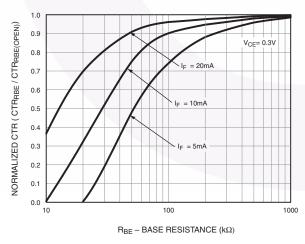
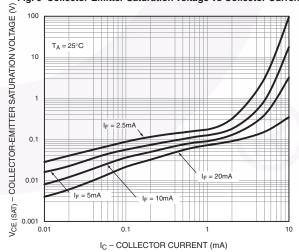
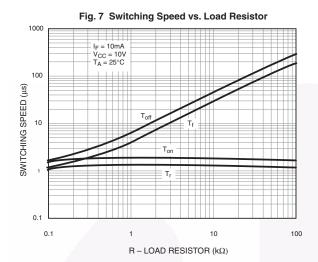
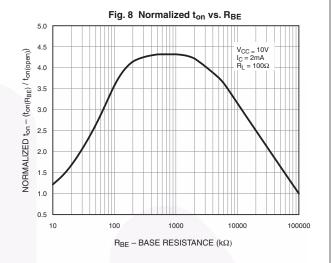


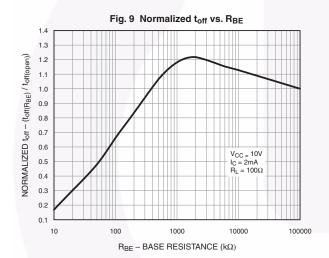
Fig. 6 Collector-Emitter Saturation Voltage vs Collector Current

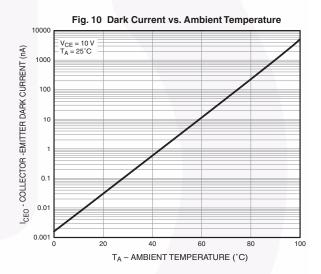


Typical Performance Curves (Continued)









Typical Electro-Optical Characteristics

TEST CIRCUIT

WAVE FORMS

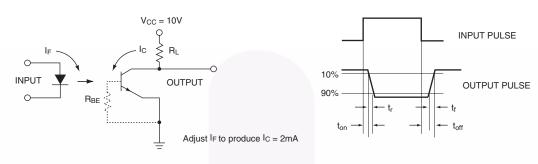


Figure 11. Switching Time Test Circuit and Waveforms

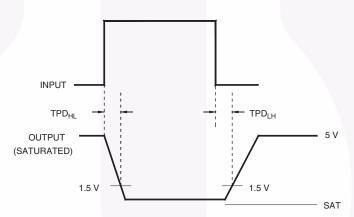
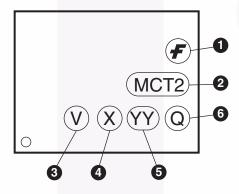


Figure 12. Switching Time Waveforms (MCT210M)

Ordering Information

| Option | Order Entry Identifier (Example) | Description |
|-----------|----------------------------------|---|
| No suffix | MCT2M | Standard Through Hole Device (50 units per tube) |
| S | MCT2SM | Surface Mount Lead Bend |
| SR2 | MCT2SR2M | Surface Mount; Tape and Reel (1,000 units per reel) |
| Т | MCT2TM | 0.4" Lead Spacing |
| V | MCT2VM | IEC60747-5-2 |
| TV | MCT2TVM | IEC60747-5-2, 0.4" Lead Spacing |
| SV | MCT2SVM | IEC60747-5-2, Surface Mount |
| SR2V | MCT2SR2VM | IEC60747-5-2, Surface Mount, Tape and Reel (1,000 units per reel) |

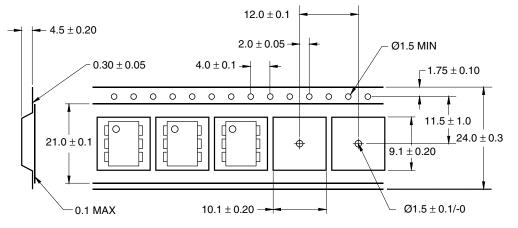
Marking Information



| Definitions | | | | | |
|-------------|--|--|--|--|--|
| 1 | Fairchild logo | | | | |
| 2 | Device number | | | | |
| 3 | VDE mark (Note: Only appears on parts ordered with VDE option – See order entry table) | | | | |
| 4 | One digit year code, e.g., '7' | | | | |
| 5 | Two digit work week ranging from '01' to '53' | | | | |
| 6 | Assembly package code | | | | |

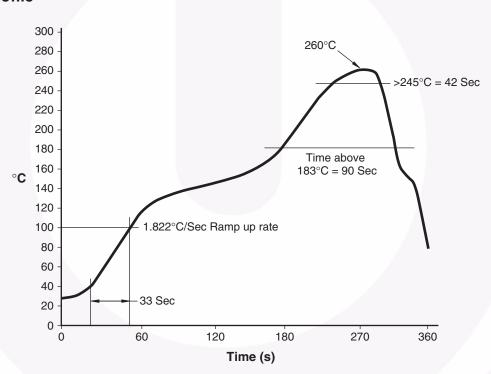
*Note – Parts that do not have the 'V' option (see definition 3 above) that are marked with date code '325' or earlier are marked in portrait format.

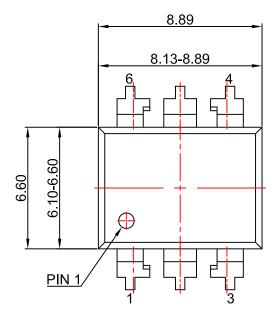
Carrier Tape Specification

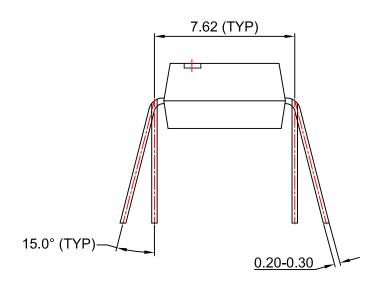


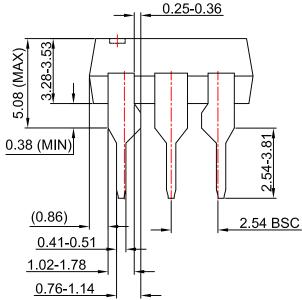
User Direction of Feed ----

Reflow Profile





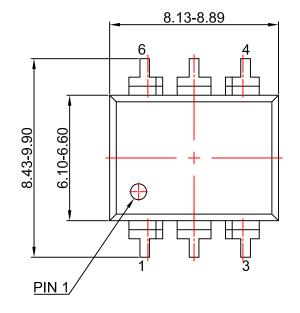


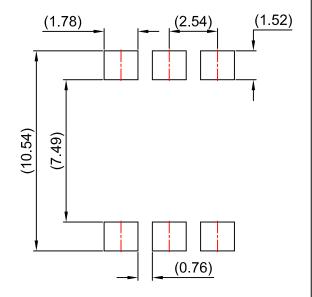


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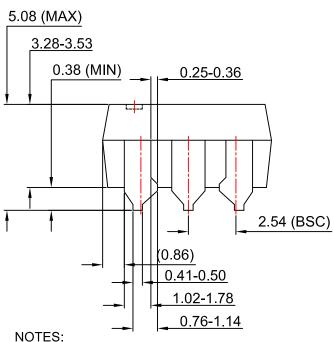
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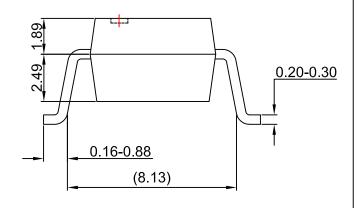






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